FAIRCHILD SEMICONDUCTOR TM

September 2013

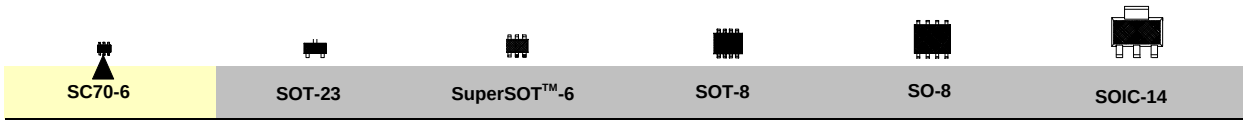
FDG6322C
Dual N & P Channel Digital FET

General Description

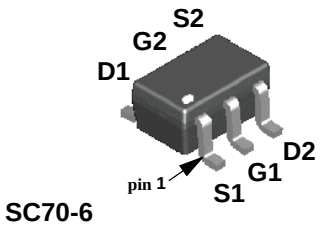
These dual N & P-Channel logic level enhancement mode field effect transistors are produced using Fairchild's proprietary, high cell density, DMOS technology. This very high density process is especially tailored to minimize on-state resistance. This device has been designed especially for low voltage applications as a replacement for bipolar digital transistors and small signal MOSFETs. Since bias resistors are not required, this dual digital FET can replace several different digital transistors, with different bias resistor values.

Features

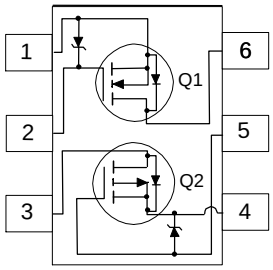
- N-Ch 0.22 A, 25 V, $R_{DS(ON)}$ = 4.0 Ω @ V_{GS}= 4.5 V,
  $R_{DS(ON)}$ = 5.0 Ω @ V_{GS}= 2.7 V.
- P-Ch -0.41 A,-25V, $R_{DS(ON)}$ = 1.1 Ω @ V_{GS}= -4.5V,
  $R_{DS(ON)}$ = 1.5 Ω @ V_{GS}= -2.7V.
- Very small package outline SC70-6.
- Very low level gate drive requirements allowing direct operation in 3 V circuits ($V_{GS(th)}$ < 1.5 V).
- Gate-Source Zener for ESD ruggedness (>6kV Human Body Model).



SC70-6 | SOT-23 | SuperSOT™-6 | SOT-8 | SO-8 | SOIC-14



SC70-6
Mark: .22



Absolute Maximum Ratings T_A = 25°C unless other wise noted

Symbol	Parameter	N-Channel	P-Channel	Units
V_{DSS}	Drain-Source Voltage	25	-25	V
V_{GSS}	Gate-Source Voltage	8	-8	V
I_D	Drain Current - Continuous	0.22	-0.41	A
	- Pulsed	0.65	-1.2	
P_D	Maximum Power Dissipation (Note 1)	0.3		W
T_J,T_{STG}	Operating and Storage Temperature Range	-55 to 150		°C
ESD	Electrostatic Discharge Rating MIL-STD-883D Human Body Model (100pf / 1500 Ohm)	6		kV
THERMAL CHARACTERISTICS				
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient (Note1)	415		°C/W

DMOS Electrical Characteristics (T_A = 25 °C unless otherwise noted)

Symbol	Parameter	Conditions	Type	Min	Typ	Max	Units
OFF CHARACTERISTICS							
BV_{DSS}	Drain-Source Breakdown Voltage	V_{GS} = 0 V, I_D = 250 µA	N-Ch	25			V
		V_{GS} = 0 V, I_D = -250 µA	P-Ch	-25			
$\Delta BV_{DSS}/\Delta T_J$	Breakdown Voltage Temp. Coefficient	I_D = 250 µA, Referenced to 25 °C	N-Ch		25		mV/°C
		I_D = -250 µA, Referenced to 25 °C	P-Ch		-22		
I_{DSS}	Zero Gate Voltage Drain Current	V_{DS} = 20 V, V_{GS} = 0 V,	N-Ch			1	µA
		T_J = 55°C				10	
I_{DSS}	Zero Gate Voltage Drain Current	V_{DS} =-20 V, V_{GS} = 0 V,	P-Ch			-1	µA
		T_J = 55°C				-10	
I_{GSS}	Gate - Body Leakage Current	V_{GS} = 8 V, V_{DS} = 0 V	N-Ch			100	nA
		V_{GS} = -8 V, V_{DS} = 0 V	P-Ch			-100	nA
ON CHARACTERISTICS (Note 2)							
$V_{GS(th)}$	Gate Threshold Voltage	V_{DS} = V_{GS}, I_D = 250 µA	N-Ch	0.65	0.85	1.5	V
		V_{DS} = V_{GS}, I_D = -250 µA	P-Ch	-0.65	-0.82	-1.5	
$\Delta V_{GS(th)}/\Delta T_J$	Gate Threshold Voltage Temp. Coefficient	I_D = 250 µA, Referenced to 25 °C	N-Ch		-2.1		mV/ °C
		I_D= -250 µA, Referenced to 25 °C	P-Ch		2.1		
$R_{DS(ON)}$	Static Drain-Source On-Resistance	V_{GS} = 4.5 V, I_D = 0.22 A	N-Ch		2.6	4	Ω
		T_J =125°C			5.3	7	
		V_{GS} = 2.7 V, I_D = 0.19 A			3.7	5	
		V_{GS} = -4.5 V, I_D = -0.41 A	P-Ch		0.85	1.1	
		T_J =125°C			1.2	1.9	
		V_{GS} = -2.7 V, I_D = -0.25 A			1.15	1.5	
$I_{D(ON)}$	On-State Drain Current	V_{GS} = 4.5 V, V_{DS} = 5 V	N-Ch	0.22			A
		V_{GS} = -4.5 V, V_{DS} = -5 V	P-Ch	-0.41			
g_{FS}	Forward Transconductance	V_{DS} = 5 V, I_D= 0.22 A	N-Ch		0.2		S
		V_{DS} = -5 V, I_D = -0.5 A	P-Ch		0.9		
DYNAMIC CHARACTERISTICS							
C_{iss}	Input Capacitance	N-Channel	N-Ch		9.5		pF
		V_{DS} = 10 V, V_{GS} = 0 V,	P-Ch		62		
C_{oss}	Output Capacitance	f = 1.0 MHz	N-Ch		6		
		P-Channel	P-Ch		34		
C_{rss}	Reverse Transfer Capacitance	V_{DS} = -10 V, V_{GS} = 0 V,	N-Ch		1.3		
		f = 1.0 MHz	P-Ch		10		

Electrical Characteristics (continued)

SWITCHING CHARACTERISTICS (Note 2)

Symbol	Parameter	Conditions	Type	Min	Typ	Max	Units
$t_{D(on)}$	Turn - On Delay Time	N-Channel	N-Ch		5	10	nS
		V_{DD} = 5 V, I_D = 0.5 A,	P-Ch		7	15	
t_r	Turn - On Rise Time	V_{GS} = 4.5 V, R_{GEN} = 50 Ω	N-Ch		4.5	10	nS
			P-Ch		8	16	
$t_{D(off)}$	Turn - Off Delay Time	P-Channel	N-Ch		4	8	nS
		V_{DD} = -5 V, I_D = -0.5 A,	P-Ch		55	80	
t_f	Turn - Off Fall Time	V_{GS} = -4.5 V, R_{GEN} = 50 Ω	N-Ch		3.2	7	nS
			P-Ch		35	60	
Q_g	Total Gate Charge	N-Channel	N-Ch		0.29	0.4	nC
		V_{DS}= 5 V, I_D = 0.22 A,	P-Ch		1.1	1.5	
Q_{gs}	Gate-Source Charge	V_{GS} = 4.5 V	N-Ch		0.12		nC
		P- Channel	P-Ch		0.31		
Q_{gd}	Gate-Drain Charge	V_{DS} = -5 V, I_D = -0.41 A,	N-Ch		0.03		nC
		V_{GS} = -4.5 V	P-Ch		0.29		
DRAIN-SOURCE DIODE CHARACTERISTICS AND MAXIMUM RATINGS							
I_S	Maximum Continuous Drain-Source Diode Forward Current		N-Ch			0.25	A
			P-Ch			-0.25	
V_{SD}	Drain-Source Diode Forward Voltage	V_{GS} = 0 V, I_S = 0.5 A (Note 2)	N-Ch		0.8	1.2	V
		V_{GS} = 0 V, I_S = -0.5 A (Note 2)	P-Ch		-0.85	-1.2	

Notes:

1. $R_{\theta JA}$ is the sum of the junction-to-case and case-to-ambient thermal resistance where the case thermal reference is defined as the solder mounting surface of the drain pins. $R_{\theta JC}$ is guaranteed by design while $R_{\theta CA}$ is determined by the user's board design. $R_{\theta JA}$ = 415°C/W on minimum mounting pad on FR-4 board in still air.
2. Pulse Test: Pulse Width ≤ 300µs, Duty Cycle ≤ 2.0%.

Typical Electrical Characteristics: N-Channel

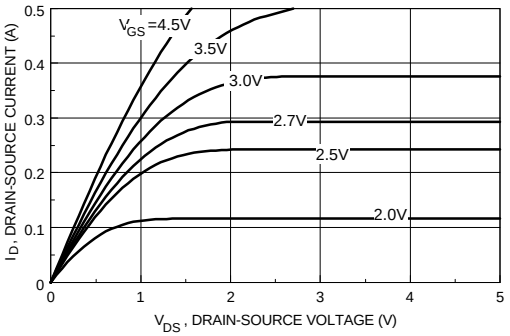


Figure 1. On-Region Characteristics.

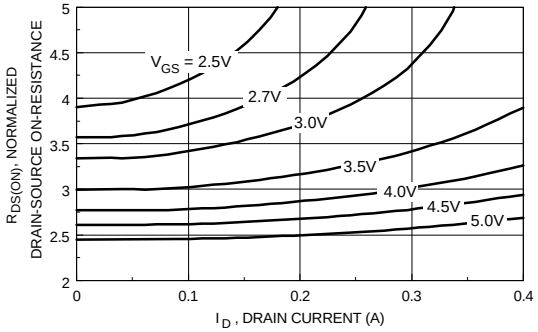


Figure 2. On-Resistance Variation with Drain Current and Gate Voltage.

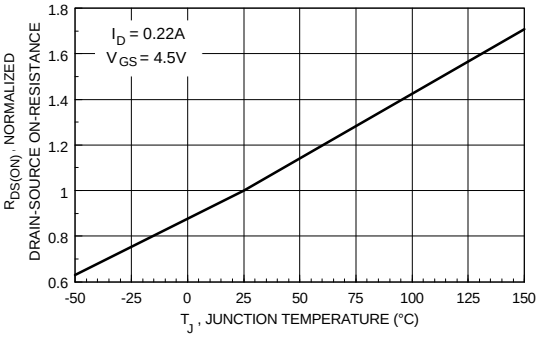


Figure 3. On-Resistance Variation with Temperature.

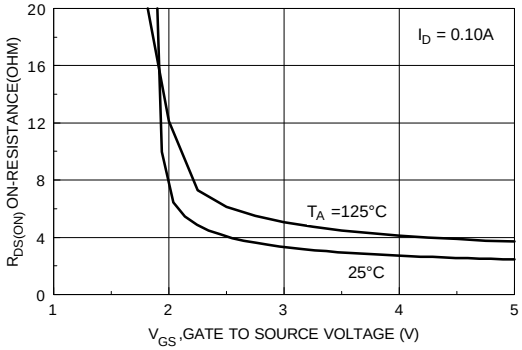


Figure 4. On-Resistance Variation with Gate-to-Source Voltage.

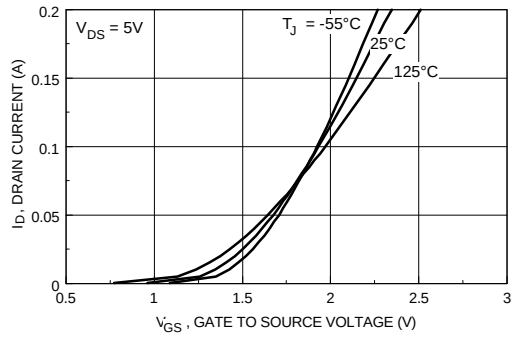


Figure 5. Transfer Characteristics.

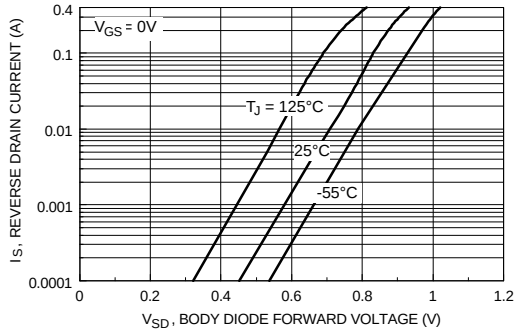


Figure 6. Body Diode Forward Voltage Variation with Source Current and Temperature.

Typical Electrical Characteristics: N-Channel (continued)

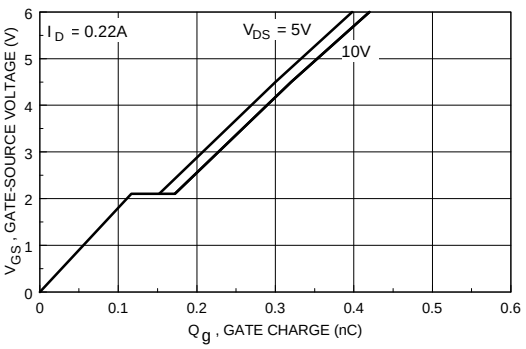


Figure 7. Gate Charge Characteristics.

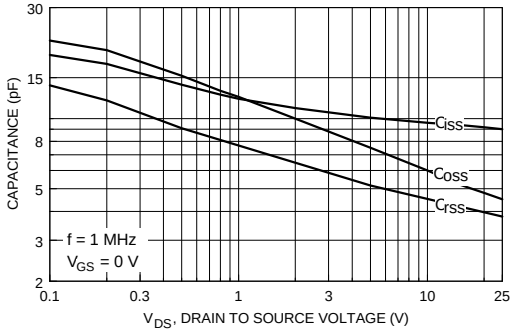


Figure 8. Capacitance Characteristics.

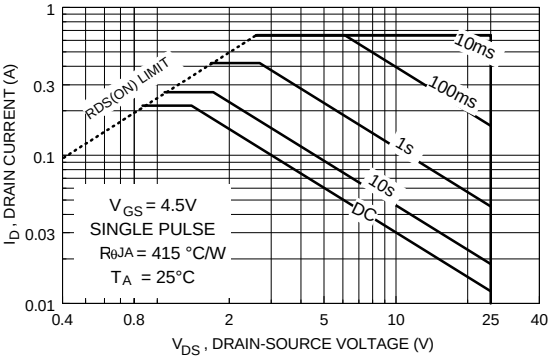


Figure 9. Maximum Safe Operating Area.

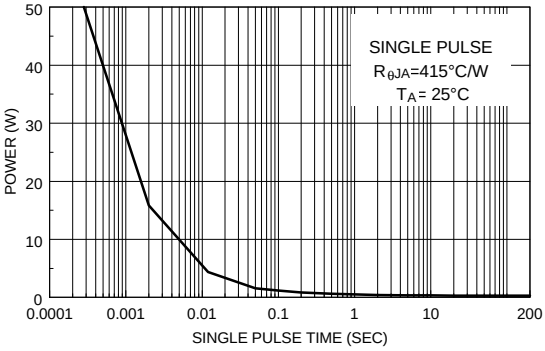


Figure 10. Single Pulse Maximum Power Dissipation.

Typical Electrical Characteristics: P-Channel

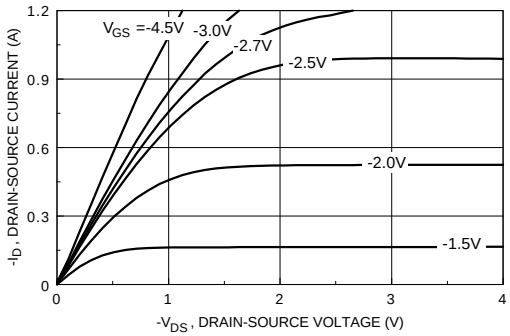


Figure 11. On-Region Characteristics.

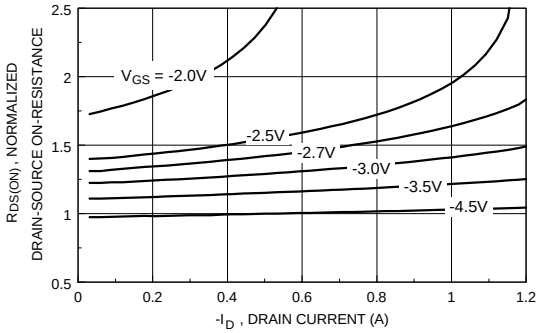


Figure 12. On-Resistance Variation with Drain Current and Gate Voltage.

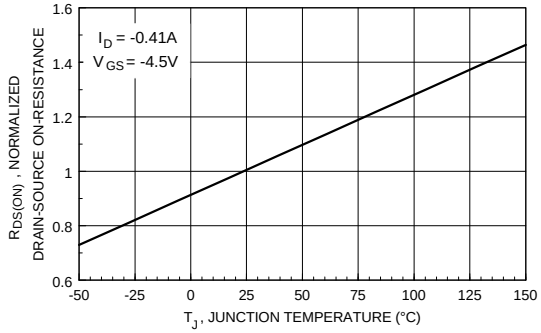


Figure 13. On-Resistance Variation with Temperature.

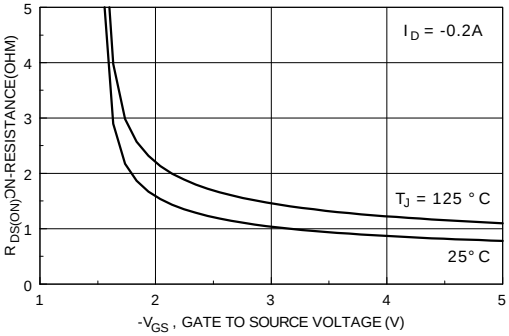


Figure 14. On-Resistance Variation with Gate-to-Source Voltage.

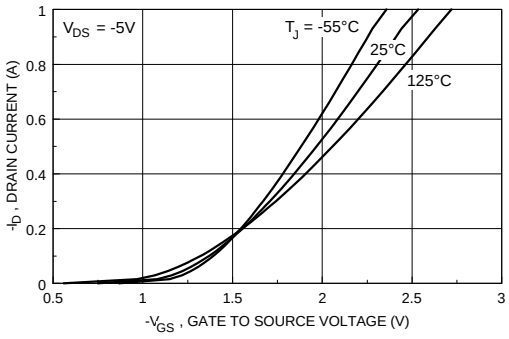


Figure 15. Transfer Characteristics.

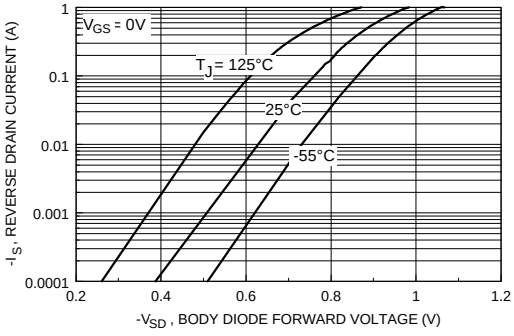


Figure 16. Body Diode Forward Voltage Variation with Source Current and Temperature.

Typical Electrical Characteristics: P-Channel (continued)

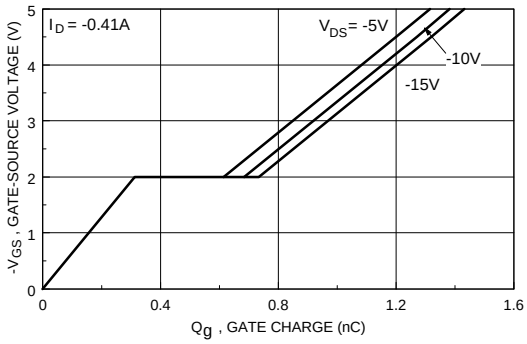


Figure 17. Gate Charge Characteristics.

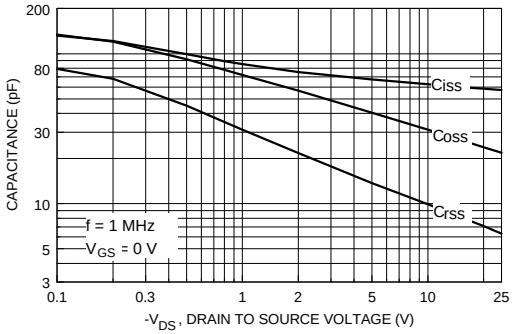


Figure 18. Capacitance Characteristics.

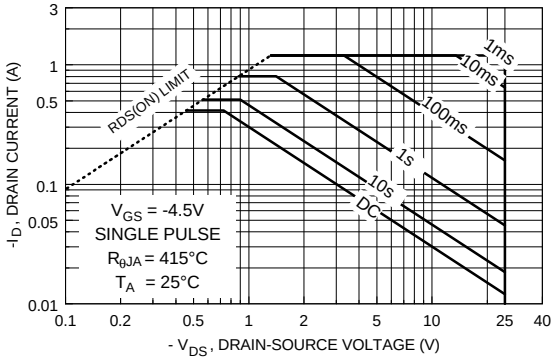


Figure 19. Maximum Safe Operating Area.

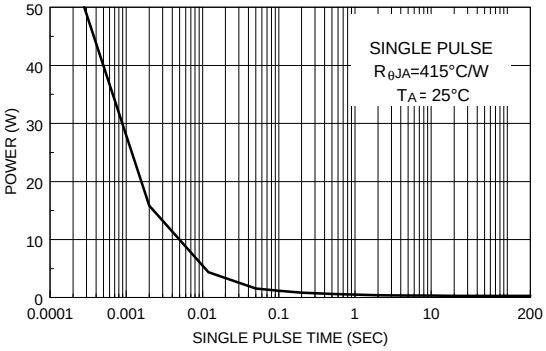


Figure 20. Single Pulse Maximum Power Dissipation.

Typical Thermal Characteristics: N & P-Channel (continued)

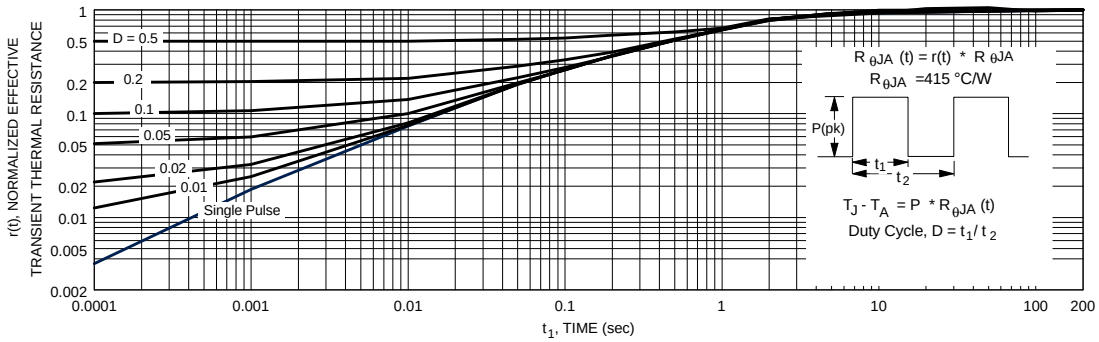


Figure 21. Transient Thermal Response Curve.

Thermal characterization performed using the conditions described in note 1.
Transient thermalresponse will change depending on the circuit board design.

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Preliminary	First Production	Datasheet contains preliminary data; supplementary data will be published at a later date. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve design.
No Identification Needed	Full Production	Datasheet contains final specifications. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve the design.
Obsolete	Not In Production	Datasheet contains specifications on a product that is discontinued by Fairchild Semiconductor. The datasheet is for reference information only.

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